

Film Capacitors

Metallized Polypropylene Film Capacitors (MKP)

Series/Type: B32620 ... B32621

Date: December 2012

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High pulse (stacked)
Typical applications

- Compact fluorescent lamps (CFL)
- SMPS

Climatic

- Max. operating temperature: 105 °C
- Climatic category (IEC 60068-1): 55/100/56

Construction

- Dielectric: polypropylene (PP)
- Stacked-film technology
- Plastic case (UL 94 V-0)
- Epoxy resin sealing

Features

- Very high pulse strength
- Very good self-healing properties
- Smallest possible dimensions
- High contact reliability
- RoHS-compatible

Terminals

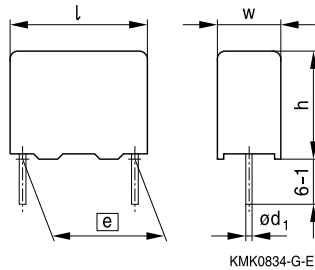
- Parallel wire leads, lead-free tinned
- Special lead lengths available on request

Marking

Manufacturer's logo,
 rated capacitance (coded),
 cap. tolerance (code letter), rated voltage,
 date of manufacture (coded),
 for lead spacing 7.5 mm: style (MKP),
 for lead spacing 10 mm: lot number, series number (621)

Delivery mode

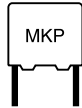
Bulk (untaped)
 Taped (Ammo pack or reel)
 For notes on taping, refer to chapter "Taping and packing".

Dimensional drawing


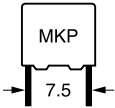
Dimensions in mm

| Lead spacing | Lead diameter | Type |
|--------------|-------------------|--------|
| $e \pm 0.4$ | d_1 | |
| 7.5 | 0.5 | B32620 |
| 10.0 | 0.6 ¹⁾ | B32621 |

 1) 0.5 mm for capacitor width $w = 4$ mm


Overview of available types

| Lead spacing | 7.5 mm | | | | | | 10.0 mm | | | | |
|------------------|--------|-----|-----|-----|------|------|---------|-----|-----|-----|------|
| Type | B32620 | | | | | | B32621 | | | | |
| Page | 4 | | | | | | 6 | | | | |
| V_R (V DC) | 160 | 250 | 400 | 630 | 1000 | 1000 | 160 | 250 | 400 | 630 | 1000 |
| V_{RMS} (V AC) | 90 | 140 | 200 | 400 | 500 | 600 | 90 | 140 | 200 | 400 | 500 |
| C_R (nF) | | | | | | | | | | | |
| 1.0 | | | | | | | | | | | |
| 1.5 | | | | | | | | | | | |
| 2.2 | | | | | | | | | | | |
| 3.3 | | | | | | | | | | | |
| 4.7 | | | | | | | | | | | |
| 6.8 | | | | | | | | | | | |
| 10 | | | | | | | | | | | |
| 15 | | | | | | | | | | | |
| 22 | | | | | | | | | | | |
| 33 | | | | | | | | | | | |
| 47 | | | | | | | | | | | |
| 68 | | | | | | | | | | | |
| 100 | | | | | | | | | | | |
| 150 | | | | | | | | | | | |
| 220 | | | | | | | | | | | |


B32620
High pulse (stacked)
Ordering codes and packing units (lead spacing 7.5 mm)

| V_R | V_{RMS} $f \leq 1$ kHz | C_R | Max. dimensions $w \times h \times l$ mm | Ordering code (composition see below) | Ammo pack pcs./MOQ | Reel pcs./ MOQ | Untaped pcs./ MOQ |
|-------|-----------------------------|-------|--|---|--------------------------|----------------------|-------------------------|
| V DC | V AC | nF | | | | | |
| 160 | 90 | 33 | 4.0 × 8.5 × 10.0 | B32620A5333+*** | 8000 | 7200 | 6000 |
| | | 47 | 4.0 × 8.5 × 10.0 | B32620A5473+*** | 8000 | 7200 | 6000 |
| | | 68 | 5.0 × 10.5 × 10.0 | B32620A5683+*** | 6400 | 5600 | 4000 |
| | | 100 | 5.0 × 10.5 × 10.0 | B32620A5104+*** | 6400 | 5600 | 4000 |
| | | 150 | 6.0 × 12.0 × 10.3 | B32620A5154+*** | 5200 | 4400 | 3000 |
| 250 | 140 | 22 | 4.0 × 8.5 × 10.0 | B32620A3223+*** | 8000 | 7200 | 6000 |
| | | 33 | 4.0 × 8.5 × 10.0 | B32620A3333+*** | 8000 | 7200 | 6000 |
| | | 47 | 5.0 × 10.5 × 10.0 | B32620A3473+*** | 6400 | 5600 | 4000 |
| | | 68 | 5.0 × 10.5 × 10.0 | B32620A3683+*** | 6400 | 5600 | 4000 |
| | | 100 | 6.0 × 12.0 × 10.3 | B32620A3104+*** | 5200 | 4400 | 3000 |
| 400 | 200 | 6.8 | 4.0 × 8.5 × 10.0 | B32620A4682+*** | 8000 | 7200 | 6000 |
| | | 10 | 4.0 × 8.5 × 10.0 | B32620A4103+*** | 8000 | 7200 | 6000 |
| | | 15 | 5.0 × 10.5 × 10.0 | B32620A4153+*** | 6400 | 5600 | 4000 |
| | | 22 | 5.0 × 10.5 × 10.0 | B32620A4223+*** | 6400 | 5600 | 4000 |
| | | 33 | 6.0 × 12.0 × 10.3 | B32620A4333+*** | 5200 | 4400 | 3000 |
| 630 | 400 | 1.5 | 4.0 × 8.5 × 10.0 | B32620A6152+*** | 8000 | 7200 | 6000 |
| | | 2.2 | 4.0 × 8.5 × 10.0 | B32620A6222+*** | 8000 | 7200 | 6000 |
| | | 3.3 | 4.0 × 8.5 × 10.0 | B32620A6332+*** | 8000 | 7200 | 6000 |
| | | 4.7 | 4.0 × 8.5 × 10.0 | B32620A6472+*** | 8000 | 7200 | 6000 |
| | | 6.8 | 5.0 × 10.5 × 10.0 | B32620A6682+*** | 6400 | 5600 | 4000 |
| | | 10 | 5.0 × 10.5 × 10.0 | B32620A6103+*** | 6400 | 5600 | 4000 |
| | | 15 | 6.0 × 12.0 × 10.3 | B32620A6153+*** | 5200 | 4400 | 3000 |
| 1000 | 500 | 1.5 | 4.0 × 8.5 × 10.0 | B32620A0152+*** | 8000 | 7200 | 6000 |
| | | 2.2 | 4.0 × 8.5 × 10.0 | B32620A0222+*** | 8000 | 7200 | 6000 |
| | | 3.3 | 5.0 × 10.5 × 10.0 | B32620A0332+*** | 6400 | 5600 | 4000 |
| | | 4.7 | 5.0 × 10.5 × 10.0 | B32620A0472+*** | 6400 | 5600 | 4000 |
| | | 6.8 | 6.0 × 12.0 × 10.3 | B32620A0682+*** | 5200 | 4400 | 3000 |

MOQ = Minimum Order Quantity, consisting of 4 packing units.
Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = ±10%

J = ±5%

*** = Packaging code:

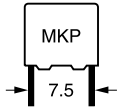
289 = Ammo pack

189 = Reel

000 = Untaped (lead length 6 – 1 mm)

B32620

High pulse (stacked)



Ordering codes and packing units (lead spacing 7.5 mm)

| V_R | V_{RMS} $f \leq 1$ kHz | C_R | Max. dimensions $w \times h \times l$ mm | Ordering code (composition see below) | Ammo pack pcs./MOQ | Reel pcs./ MOQ | Untaped pcs./ MOQ |
|-------|-----------------------------|-------|--|---|--------------------------|----------------------|-------------------------|
| V DC | V AC | nF | | | | | |
| 1000 | 600 | 1.0 | $5.0 \times 10.5 \times 10.0$ | B32620J0102+*** | 6400 | 5600 | 4000 |
| | | 1.5 | $5.0 \times 10.5 \times 10.0$ | B32620J0152+*** | 6400 | 5600 | 4000 |
| | | 2.2 | $5.0 \times 10.5 \times 10.0$ | B32620J0222+*** | 6400 | 5600 | 4000 |
| | | 3.3 | $5.0 \times 10.5 \times 10.0$ | B32620J0332+*** | 6400 | 5600 | 4000 |
| | | 4.7 | $6.0 \times 12.0 \times 10.3$ | B32620J0472+*** | 5200 | 4400 | 3000 |

MOQ = Minimum Order Quantity, consisting of 4 packing units.
Further E series and intermediate capacitance values on request.

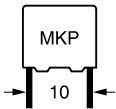
Composition of ordering code

+ = Capacitance tolerance code:

K = $\pm 10\%$
J = $\pm 5\%$

*** = Packaging code:

289 = Ammo pack
189 = Reel
000 = Untaped (lead length 6 – 1 mm)


B32621
High pulse (stacked)
Ordering codes and packing units (lead spacing 10 mm)

| V_R | V_{RMS} $f \leq 1$ kHz | C_R | Max. dimensions $w \times h \times l$ mm | Ordering code (composition see below) | Ammo pack pcs./MOQ | Reel pcs./ MOQ | Untaped pcs./ MOQ |
|-------|-----------------------------|-------|--|---|--------------------------|----------------------|-------------------------|
| V DC | V AC | nF | | | | | |
| 160 | 90 | 47 | 4.0 × 7.0 × 13.0 | B32621A5473+*** | 4000 | 6800 | 4000 |
| | | 68 | 4.0 × 9.0 × 13.0 | B32621A5683+*** | 4000 | 6800 | 4000 |
| | | 100 | 5.0 × 11.0 × 13.0 | B32621A5104+*** | 3320 | 5200 | 4000 |
| | | 150 | 5.0 × 11.0 × 13.0 | B32621A5154+*** | 3320 | 5200 | 4000 |
| | | 220 | 6.0 × 12.0 × 13.0 | B32621A5224+*** | 2720 | 4400 | 4000 |
| | | 250 | 140 | 2.2 | 4.0 × 7.0 × 13.0 | B32621A3222+*** | 4000 |
| 3.3 | 4.0 × 9.0 × 13.0 | | | B32621A3332+*** | 4000 | 6800 | 4000 |
| 4.7 | 4.0 × 9.0 × 13.0 | | | B32621A3472+*** | 4000 | 6800 | 4000 |
| 6.8 | 4.0 × 9.0 × 13.0 | | | B32621A3682+*** | 4000 | 6800 | 4000 |
| 10 | 4.0 × 9.0 × 13.0 | | | B32621A3103+*** | 4000 | 6800 | 4000 |
| 15 | 4.0 × 9.0 × 13.0 | | | B32621A3153+*** | 4000 | 6800 | 4000 |
| 22 | 4.0 × 9.0 × 13.0 | | | B32621A3223+*** | 4000 | 6800 | 4000 |
| 33 | 4.0 × 9.0 × 13.0 | | | B32621A3333+*** | 4000 | 6800 | 4000 |
| 47 | 4.0 × 9.0 × 13.0 | | | B32621A3473+*** | 4000 | 6800 | 4000 |
| 68 | 5.0 × 11.0 × 13.0 | | | B32621A3683+*** | 3320 | 5200 | 4000 |
| 100 | 6.0 × 12.0 × 13.0 | | | B32621A3104+*** | 2720 | 4400 | 4000 |
| 400 | 200 | | | 10 | 4.0 × 9.0 × 13.0 | B32621A4103+*** | 4000 |
| | | 15 | 4.0 × 9.0 × 13.0 | B32621A4153+*** | 4000 | 6800 | 4000 |
| | | 22 | 5.0 × 11.0 × 13.0 | B32621A4223+*** | 3320 | 5200 | 4000 |
| | | 33 | 5.0 × 11.0 × 13.0 | B32621A4333+*** | 3320 | 5200 | 4000 |
| | | 47 | 6.0 × 12.0 × 13.0 | B32621A4473+*** | 2720 | 4400 | 4000 |
| | | 630 | 400 | 2.2 | 4.0 × 7.0 × 13.0 | B32621A6222+*** | 4000 |
| 3.3 | 4.0 × 9.0 × 13.0 | | | B32621A6332+*** | 4000 | 6800 | 4000 |
| 4.7 | 4.0 × 9.0 × 13.0 | | | B32621A6472+*** | 4000 | 6800 | 4000 |
| 6.8 | 4.0 × 9.0 × 13.0 | | | B32621A6682+*** | 4000 | 6800 | 4000 |
| 10 | 4.0 × 9.0 × 13.0 | | | B32621A6103+*** | 4000 | 6800 | 4000 |
| 15 | 5.0 × 11.0 × 13.0 | | | B32621A6153+*** | 3320 | 5200 | 4000 |
| 22 | 6.0 × 12.0 × 13.0 | | | B32621A6223+*** | 2720 | 4400 | 4000 |
| 33 | 6.0 × 12.0 × 13.0 | | | B32621A6333+*** | 2720 | 4400 | 4000 |

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = ±10%

J = ±5%

*** = Packaging code:

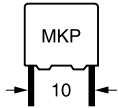
289 = Ammo pack

189 = Reel

000 = Untaped (lead length 6 – 1 mm)

B32621

High pulse (stacked)



Ordering codes and packing units (lead spacing 10 mm)

| V_R | V_{RMS} $f \leq 1$ kHz | C_R | Max. dimensions $w \times h \times l$ mm | Ordering code (composition see below) | Ammo pack pcs./MOQ | Reel pcs./ MOQ | Untaped pcs./ MOQ |
|-------|-----------------------------|-------|--|---|--------------------------|----------------------|-------------------------|
| V DC | V AC | nF | | | | | |
| 1000 | 500 | 2.2 | 4.0 × 7.0 × 13.0 | B32621A0222+*** | 4000 | 6800 | 4000 |
| | | 3.3 | 4.0 × 9.0 × 13.0 | B32621A0332+*** | 4000 | 6800 | 4000 |
| | | 4.7 | 4.0 × 9.0 × 13.0 | B32621A0472+*** | 4000 | 6800 | 4000 |
| | | 6.8 | 5.0 × 11.0 × 13.0 | B32621A0682+*** | 3320 | 5200 | 4000 |
| | | 10 | 6.0 × 12.0 × 13.0 | B32621A0103+*** | 2720 | 4400 | 4000 |

MOQ = Minimum Order Quantity, consisting of 4 packing units.
Further E series and intermediate capacitance values on request.

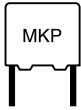
Composition of ordering code

+ = Capacitance tolerance code:

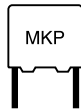
K = ±10%
J = ±5%

*** = Packaging code:

289 = Ammo pack
189 = Reel
000 = Untaped (lead length 6 –1 mm)


B32620 ... B32621
High pulse (stacked)
Technical data

| | | | |
|---|--|---|--|
| Operating temperature range | Max. operating temperature $T_{op,max}$ | | +105 °C |
| | Upper category temperature T_{max} | | +100 °C |
| | Lower category temperature T_{min} | | -55 °C |
| | Rated temperature T_R | | +85 °C |
| Dissipation factor $\tan \delta$ (in 10^{-3}) at 20 °C (upper limit values) | at | $C_R \leq 0.1 \mu\text{F}$ | $0.1 \mu\text{F} < C_R \leq 0.22 \mu\text{F}$ |
| | 1 kHz | — | 1.0 |
| | 10 kHz | — | 1.5 |
| | 100 kHz | 4.0 | — |
| Insulation resistance R_{ins} at 20 °C, rel. humidity $\leq 65\%$ (minimum as-delivered values) | 100 G Ω | | |
| DC test voltage | $1.6 \cdot V_R$, 2 s | | |
| Category voltage V_C (continuous operation with V_{DC} or V_{AC} at $f \leq 1$ kHz) | T_A (°C) | DC voltage derating | AC voltage derating |
| | $T_A \leq 85$ $85 < T_A \leq 100$ | $V_C = V_R$ $V_C = V_R \cdot (165 - T_A)/80$ | $V_{C,RMS} = V_{RMS}$ $V_{C,RMS} = V_{RMS} \cdot (165 - T_A)/80$ |
| Operating voltage V_{op} for short operating periods (V_{DC} or V_{AC} at $f \leq 1$ kHz) | T_A (°C) | DC voltage (max. hours) | AC voltage (max. hours) |
| | $T_A \leq 85$ $85 < T_A \leq 100$ | $V_{op} = 1.25 \cdot V_C$ (2000 h) $V_{op} = 1.25 \cdot V_C$ (1000 h) | $V_{op} = 1.0 \cdot V_{C,RMS}$ (2000 h) $V_{op} = 1.0 \cdot V_{C,RMS}$ (1000 h) |
| Damp heat test Limit values after damp heat test | 56 days/40 °C/93% relative humidity | | |
| | Capacitance change $ \Delta C/C $ | $\leq 3\%$ | |
| | Dissipation factor change $\Delta \tan \delta$ | $\leq 0.5 \cdot 10^{-3}$ (at 1 kHz) $\leq 1.0 \cdot 10^{-3}$ (at 10 kHz) | |
| | Insulation resistance R_{ins} | $\geq 50\%$ of minimum as-delivered values | |
| Reliability: Failure rate λ Service life t_{SL} | 1 fit ($\leq 1 \cdot 10^{-9}/\text{h}$) at $0.5 \cdot V_R$, 40 °C 200 000 h at $1.0 \cdot V_R$, 85 °C For conversion to other operating conditions and temperatures, refer to chapter "Quality, 2 Reliability". | | |
| Failure criteria: Total failure Failure due to variation of parameters | Short circuit or open circuit | | |
| | Capacitance change $ \Delta C/C $ | $> \pm 10\%$ | |
| | Dissipation factor $\tan \delta$ | $> 4 \cdot$ upper limit value | |
| | Insulation resistance R_{ins} | $< 1500 \text{ M}\Omega$ | |



Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/ μ s.

"k₀" represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V²/ μ s.

Note:

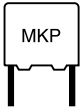
The values of dV/dt and k₀ provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt values

| Lead spacing | | 7.5 mm | 10 mm |
|------------------------|--------------------------|---------------------|-------|
| V _R V DC | V _{RMS} V AC | dV/dt in V/ μ s | |
| 160 | 90 | 750 | 600 |
| 250 | 140 | 1 200 | 900 |
| 400 | 200 | 1 500 | 1 050 |
| 630 | 400 | 2 700 | 1 800 |
| 1 000 | 500 | 3 200 | 2 400 |
| 1 000 | 600 | 4 000 | – |

k₀ values

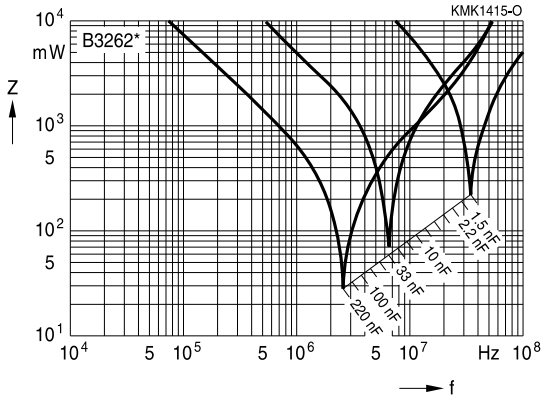
| Lead spacing | | 7.5 mm | 10 mm |
|------------------------|--------------------------|--|-----------|
| V _R V DC | V _{RMS} V AC | k ₀ in V ² / μ s | |
| 160 | 90 | 240 000 | 190 000 |
| 250 | 140 | 600 000 | 450 000 |
| 400 | 200 | 1 200 000 | 840 000 |
| 630 | 400 | 3 400 000 | 2 250 000 |
| 1 000 | 500 | 6 400 000 | 4 800 000 |
| 1 000 | 600 | 8 000 000 | – |



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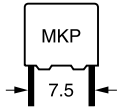
High pulse (stacked)

Impedance Z versus frequency f
(typical values)



B32620

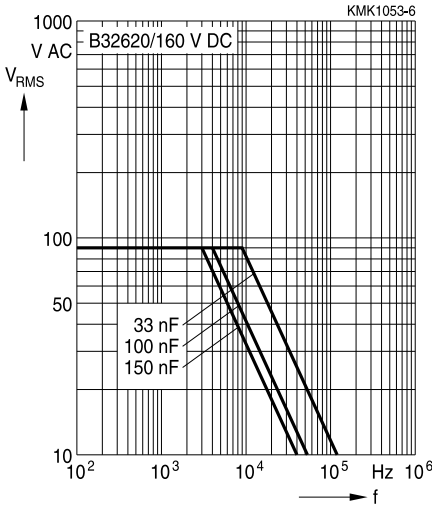
High pulse (stacked)



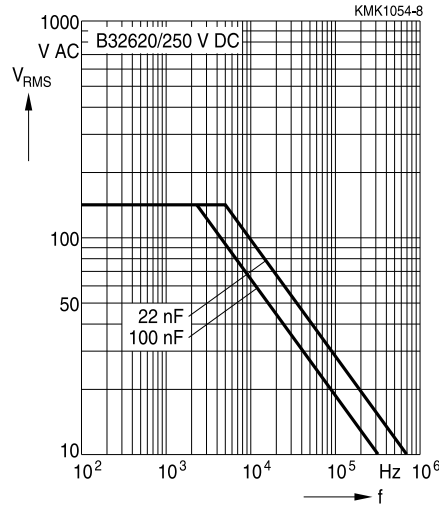
Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90^\circ C$)
 For $T_A > 90^\circ C$, please refer to "General technical information", section 3.2.3.

Lead spacing 7.5 mm

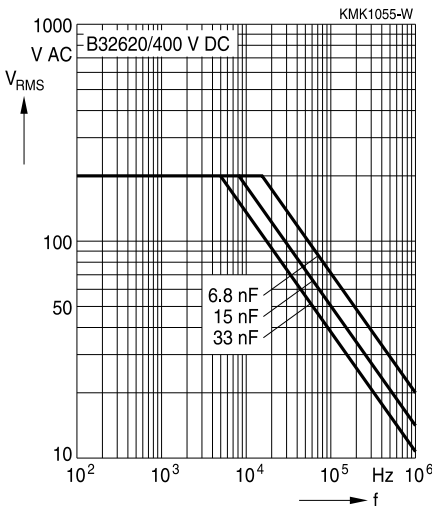
160 V DC/90 V AC



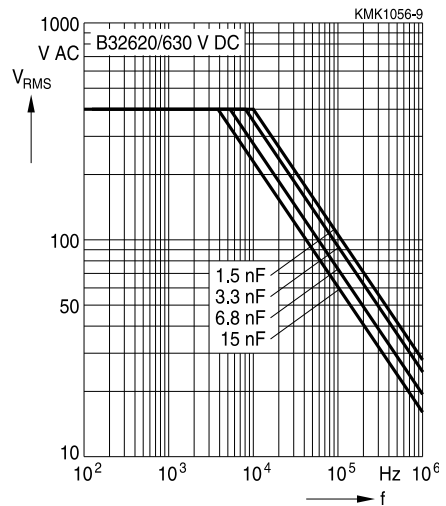
250 V DC/140 V AC

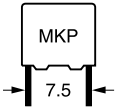


400 V DC/200 V AC



630 V DC/400 V AC





B32620

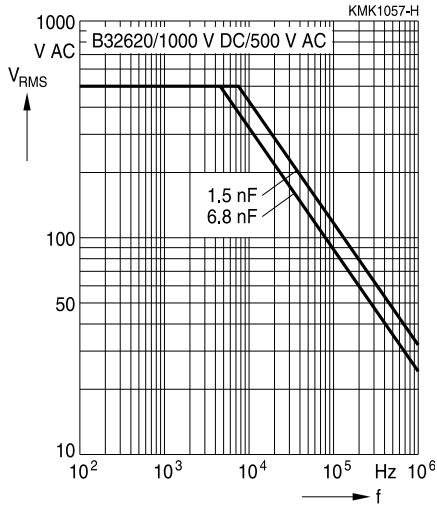
High pulse (stacked)

Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90^\circ C$)

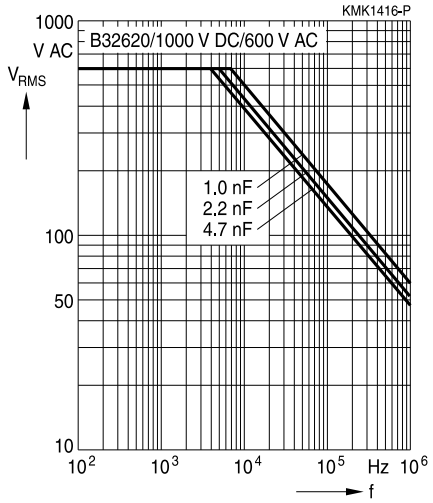
For $T_A > 90^\circ C$, please refer to "General technical information", section 3.2.3.

Lead spacing 7.5 mm

1000 V DC/500 V AC

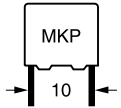


1000 V DC/600 V AC



B32621

High pulse (stacked)

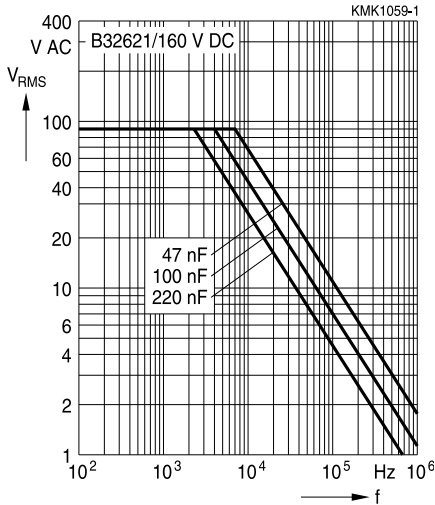


Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90^\circ C$)

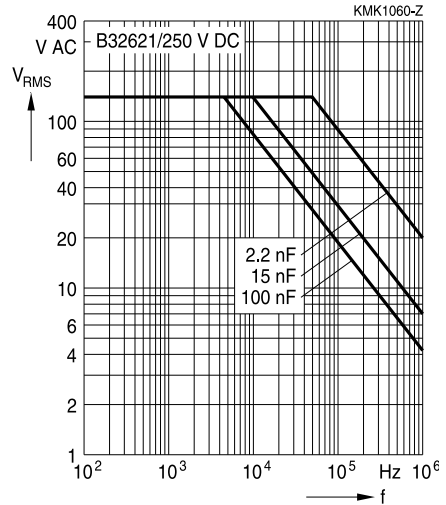
For $T_A > 90^\circ C$, please refer to "General technical information", section 3.2.3.

Lead spacing 10 mm

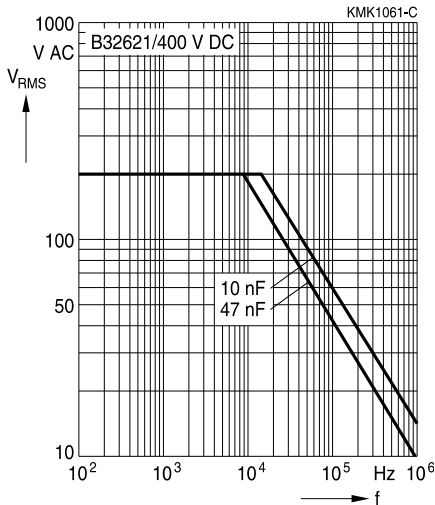
160 V DC/90 V AC



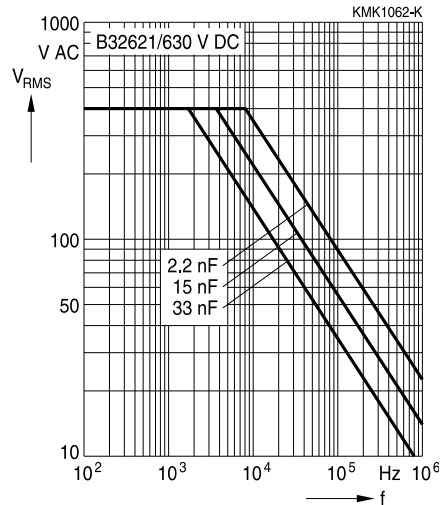
250 V DC/140 V AC

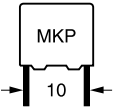


400 V DC/200 V AC



630 V DC/400 V AC





B32621

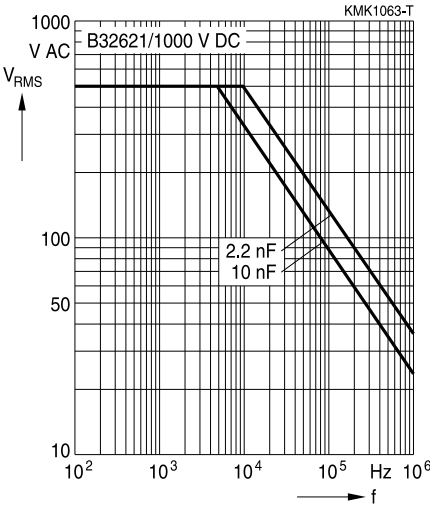
High pulse (stacked)

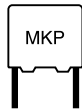
Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90\text{ °C}$)

For $T_A > 90\text{ °C}$, please refer to "General technical information", section 3.2.3.

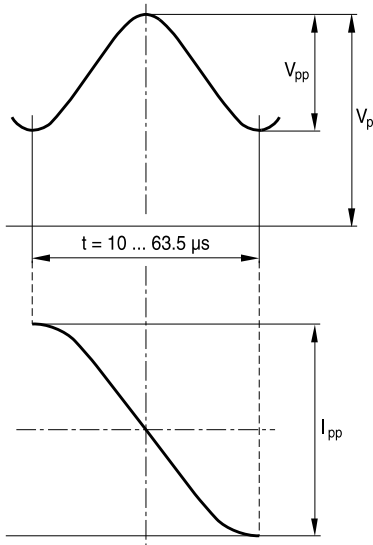
Lead spacing 10 mm

1000 V DC/500 V AC

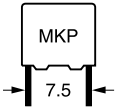




Sinus-wave application, lighting
Permissible voltage and current / waveform



KMK0721-D



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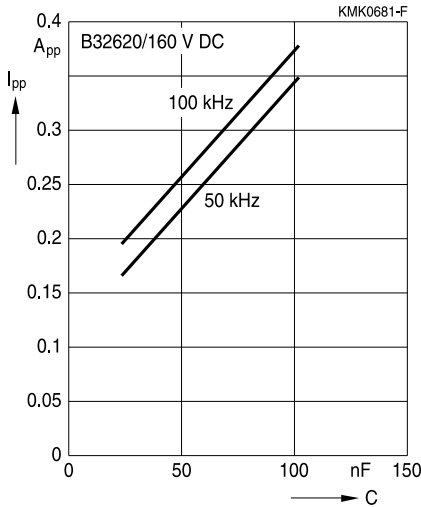
High pulse (stacked)

Sinus-wave application, lighting

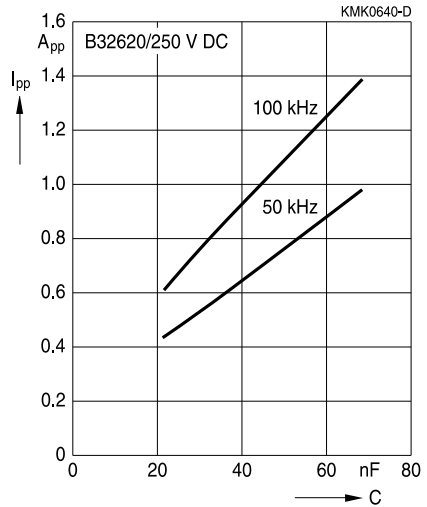
Permissible current I_{pp} versus rated capacitance C_R

Lead spacing 7.5 mm

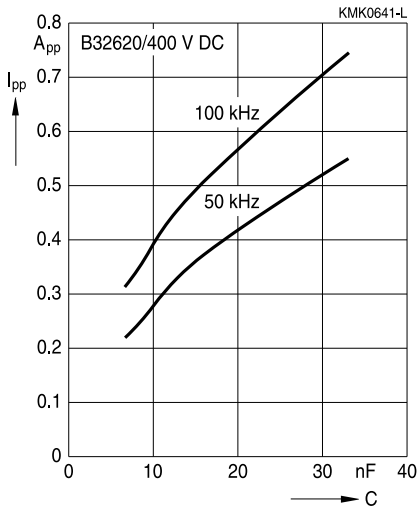
160 V DC/90 V AC



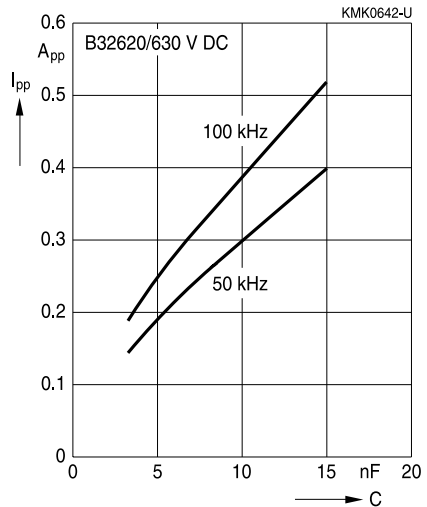
250 V DC/140 V AC



400 V DC/200 V AC

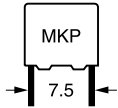


630 V DC/400 V AC



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High pulse (stacked)

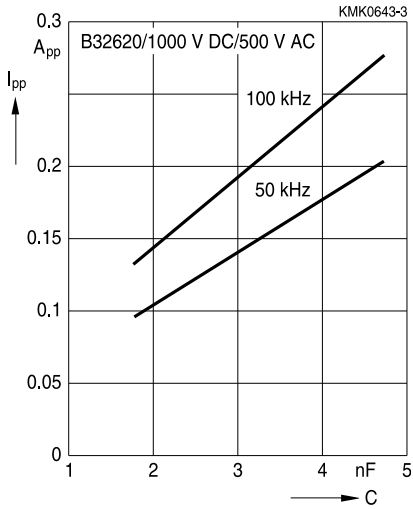


Sinus-wave application, lighting

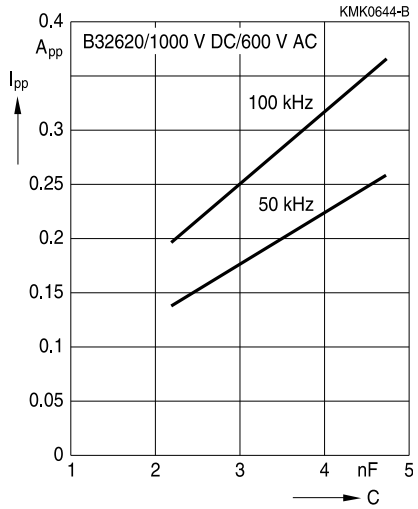
Permissible current I_{pp} versus rated capacitance C_R

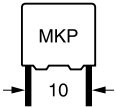
Lead spacing 7.5 mm

1000 V DC/500 V AC



1000 V DC/600 V AC





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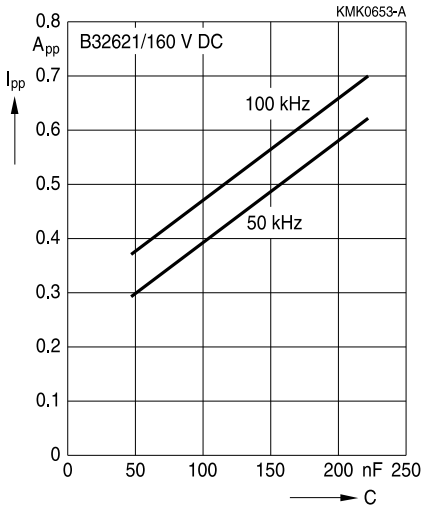
High pulse (stacked)

Sinus-wave application, lighting

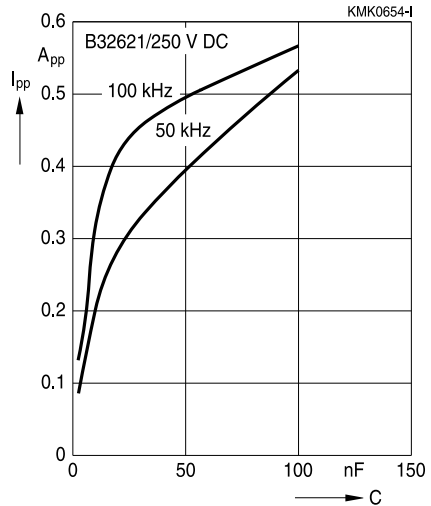
Permissible current I_{pp} versus rated capacitance C_R

Lead spacing 10 mm

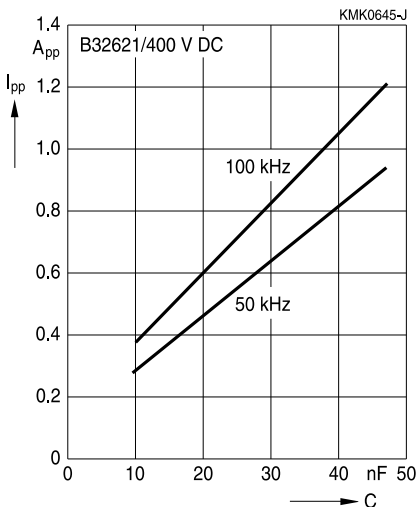
160 V DC/90 V AC



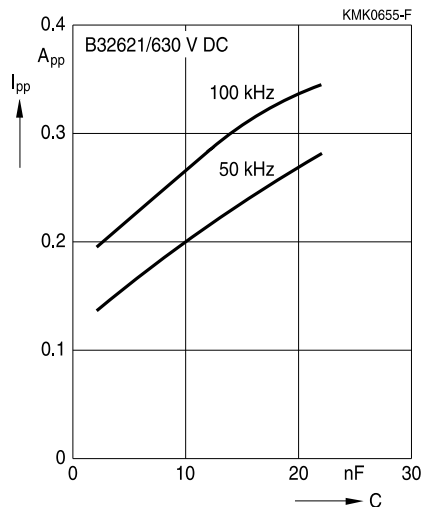
250 V DC/140 V AC

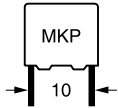


400 V DC/200 V AC



630 V DC/400 V AC



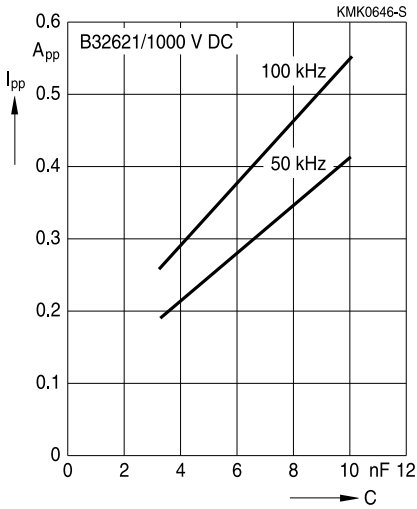


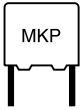
Sinus-wave application, lighting

Permissible current I_{pp} versus rated capacitance C_R

Lead spacing 10 mm

1000 V DC/500 V AC





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High pulse (stacked)

Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

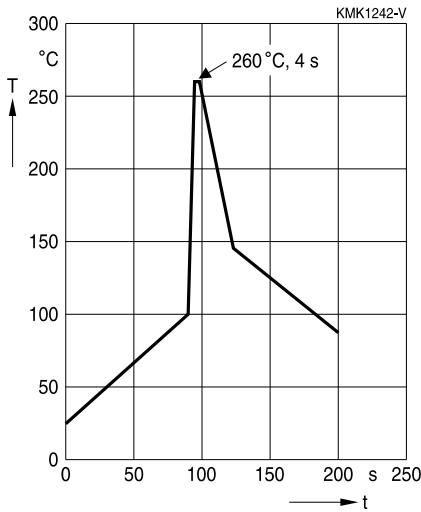
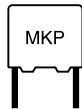
| | |
|-------------------------|---|
| Solder bath temperature | 235 ±5 °C |
| Soldering time | 2.0 ±0.5 s |
| Immersion depth | 2.0 +0/-0.5 mm from capacitor body or seating plane |
| Evaluation criteria: | |
| Visual inspection | Wetting of wire surface by new solder ≥90%, free-flowing solder |

1.2 Resistance to soldering heat

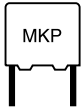
Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A.

Conditions:

| Series | Solder bath temperature | Soldering time |
|--|-------------------------|--|
| MKT boxed (except 2.5 × 6.5 × 7.2 mm) coated uncoated (lead spacing > 10 mm) | 260 ±5 °C | 10 ±1 s |
| MFP MKP (lead spacing > 7.5 mm) | | |
| MKT boxed (case 2.5 × 6.5 × 7.2 mm) | | 5 ±1 s |
| MKP (lead spacing ≤ 7.5 mm) | | < 4 s |
| MKT uncoated (lead spacing ≤ 10 mm) insulated (B32559) | | recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559) |



| | |
|----------------------|---|
| Immersion depth | 2.0 +0/−0.5 mm from capacitor body or seating plane |
| Shield | Heat-absorbing board, (1.5 ±0.5) mm thick, between capacitor body and liquid solder |
| Evaluation criteria: | |
| Visual inspection | No visible damage |
| $\Delta C/C_0$ | 2% for MKT/MKP/MFP 5% for EMI suppression capacitors |
| $\tan \delta$ | As specified in sectional specification |



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High pulse (stacked)

1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
 - diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

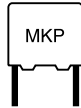
EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
 - MKP/MFP 110 °C
 - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

Uncoated capacitors

For uncoated MKT capacitors with lead spacings ≤ 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

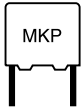


Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

| Topic | Safety information | Reference chapter "General technical information" |
|-------------------------|---|--|
| Storage conditions | Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions. | 4.5 "Storage conditions" |
| Flammability | Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials. | 5.3 "Flammability" |
| Resistance to vibration | Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics". | 5.2 "Resistance to vibration" |



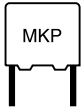
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High pulse (stacked)

| Topic | Safety information | Reference chapter "Mounting guidelines" |
|--|---|--|
| Soldering | Do not exceed the specified time or temperature limits during soldering. | 1 "Soldering" |
| Cleaning | Use only suitable solvents for cleaning capacitors. | 2 "Cleaning" |
| Embedding of capacitors in finished assemblies | When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types! | 3 "Embedding of capacitors in finished assemblies" |

Symbols and terms

| Symbol | English | German |
|----------------------|---|---|
| α | Heat transfer coefficient | Wärmeübergangszahl |
| α_C | Temperature coefficient of capacitance | Temperaturkoeffizient der Kapazität |
| A | Capacitor surface area | Kondensatoroberfläche |
| β_C | Humidity coefficient of capacitance | Feuchtekoeffizient der Kapazität |
| C | Capacitance | Kapazität |
| C_R | Rated capacitance | Nennkapazität |
| ΔC | Absolute capacitance change | Absolute Kapazitätsänderung |
| $\Delta C/C$ | Relative capacitance change (relative deviation of actual value) | Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert) |
| $\Delta C/C_R$ | Capacitance tolerance (relative deviation from rated capacitance) | Kapazitätstoleranz (relative Abweichung vom Nennwert) |
| dt | Time differential | Differentielle Zeit |
| Δt | Time interval | Zeitintervall |
| ΔT | Absolute temperature change (self-heating) | Absolute Temperaturänderung (Selbsterwärmung) |
| $\Delta \tan \delta$ | Absolute change of dissipation factor | Absolute Änderung des Verlustfaktors |
| ΔV | Absolute voltage change | Absolute Spannungsänderung |
| dV/dt | Time differential of voltage function (rate of voltage rise) | Differentielle Spannungsänderung (Spannungsflankensteilheit) |
| $\Delta V/\Delta t$ | Voltage change per time interval | Spannungsänderung pro Zeitintervall |
| E | Activation energy for diffusion | Aktivierungsenergie zur Diffusion |
| ESL | Self-inductance | Eigeninduktivität |
| ESR | Equivalent series resistance | Ersatz-Serienwiderstand |
| f | Frequency | Frequenz |
| f_1 | Frequency limit for reducing permissible AC voltage due to thermal limits | Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung |
| f_2 | Frequency limit for reducing permissible AC voltage due to current limit | Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung |
| f_r | Resonant frequency | Resonanzfrequenz |
| F_D | Thermal acceleration factor for diffusion | Therm. Beschleunigungsfaktor zur Diffusion |
| F_T | Derating factor | Deratingfaktor |
| i | Current (peak) | Stromspitze |
| I_C | Category current (max. continuous current) | Kategoriestrom (max. Dauerstrom) |



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High pulse (stacked)

| Symbol | English | German |
|------------------|--|---|
| I_{RMS} | (Sinusoidal) alternating current, root-mean-square value | (Sinusförmiger) Wechselstrom |
| i_z | Capacitance drift | Inkonstanz der Kapazität |
| k_0 | Pulse characteristic | Impuls kennwert |
| L_S | Series inductance | Serieninduktivität |
| λ | Failure rate | Ausfallrate |
| λ_0 | Constant failure rate during useful service life | Konstante Ausfallrate in der Nutzungsphase |
| λ_{test} | Failure rate, determined by tests | Experimentell ermittelte Ausfallrate |
| P_{diss} | Dissipated power | Abgegebene Verlustleistung |
| P_{gen} | Generated power | Erzeugte Verlustleistung |
| Q | Heat energy | Wärmeenergie |
| ρ | Density of water vapor in air | Dichte von Wasserdampf in Luft |
| R | Universal molar constant for gases | Allg. Molarkonstante für Gas |
| R | Ohmic resistance of discharge circuit | Ohmscher Widerstand des Entladekreises |
| R_i | Internal resistance | Innenwiderstand |
| R_{ins} | Insulation resistance | Isolationswiderstand |
| R_P | Parallel resistance | Parallelwiderstand |
| R_S | Series resistance | Serienwiderstand |
| S | severity (humidity test) | Schärfegrad (Feuchtest) |
| t | Time | Zeit |
| T | Temperature | Temperatur |
| τ | Time constant | Zeitkonstante |
| $\tan \delta$ | Dissipation factor | Verlustfaktor |
| $\tan \delta_D$ | Dielectric component of dissipation factor | Dielektrischer Anteil des Verlustfaktors |
| $\tan \delta_P$ | Parallel component of dissipation factor | Parallelanteil des Verlustfaktors |
| $\tan \delta_S$ | Series component of dissipation factor | Serienanteil des Verlustfaktors |
| T_A | Ambient temperature | Umgebungstemperatur |
| T_{max} | Upper category temperature | Obere Kategorietemperatur |
| T_{min} | Lower category temperature | Untere Kategorietemperatur |
| t_{OL} | Operating life at operating temperature and voltage | Betriebszeit bei Betriebstemperatur und -spannung |
| T_{op} | Operating temperature | Betriebstemperatur |
| T_R | Rated temperature | Nenntemperatur |
| T_{ref} | Reference temperature | Referenztemperatur |
| t_{SL} | Reference service life | Referenz-Lebensdauer |
| V_{AC} | AC voltage | Wechselspannung |

| Symbol | English | German |
|-------------|---|---|
| V_C | Category voltage | Kategorie spannung |
| $V_{C,RMS}$ | Category AC voltage | (Sinusförmige) Kategorie-Wechsel spannung |
| V_{CD} | Corona-discharge onset voltage | Teilentlade-Einsatz spannung |
| V_{ch} | Charging voltage | Ladespannung |
| V_{DC} | DC voltage | Gleichspannung |
| V_{FB} | Fly-back capacitor voltage | Spannung (Flyback) |
| V_i | Input voltage | Eingangsspannung |
| V_o | Output voltage | Ausgangssspannung |
| V_{op} | Operating voltage | Betriebsspannung |
| V_p | Peak pulse voltage | Impuls-Spitzen spannung |
| V_{pp} | Peak-to-peak voltage Impedance | Spannungshub |
| V_R | Rated voltage | Nennspannung |
| \hat{V}_R | Amplitude of rated AC voltage | Amplitude der Nenn-Wechsel spannung |
| V_{RMS} | (Sinusoidal) alternating voltage, root-mean-square value | (Sinusförmige) Wechsel spannung |
| V_{SC} | S-correction voltage | Spannung bei Anwendung "S-correction" |
| V_{sn} | Snubber capacitor voltage | Spannung bei Anwendung "Beschaltung" |
| Z | Impedance | Scheinwiderstand |
| e | Lead spacing | Rastermaß |

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